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1-20-04

FINANCE SECTION  
JAN 20 2004  
OFFICE OF THE COMMISSIONER OF PATENTS AND TRADEMARKS

Please record the attached original documents or copies thereof.

1. Name of conveying party(ies):  
**Arch Specialty Chemicals, Inc.**

2. Name and address of receiving party(ies):  
**Planar Solutions LLC  
3301 Sutton Road  
Adrain, Michigan 49221**

3. Nature of conveyance:  
XXXX Assignment \_\_\_\_\_ Merger  
\_\_\_\_\_ Security Agreement \_\_\_\_\_ Change of Name  
\_\_\_\_\_ Other: \_\_\_\_\_  
Execution Date: December 18, 2003

4. Application number(s) or application date(s):  
If this document is being filed together with a new application, the execution date of the application is:

A. <u>Application/Patent Nos.</u>	B. <u>Application/Issue Date</u>
09/845,549	April 30, 2001
<del>10/268,254</del>	October 9, 2002
10/281,905	October 28, 2002
6,468,913	October 22, 2002

5. Name and address of party to whom correspondence concerning this document should be mailed:

Paul D. Greeley, Esq.  
Ohlandt, Greeley, Ruggiero & Perle, L.L.P.  
One Landmark Square, 10<sup>th</sup> Floor  
Stamford, Connecticut 06901-2682 U.S.A.

6. Total No. of applications and patents involved: 4.

7. Total Fee (37 C.F.R. 3.41(h)) \$160.00/assignments.

XXXXX CUSTOMER NO.: 27623

XXXXX Enclosed

Authorized to be charged to deposit account.

The Commissioner is hereby authorized to charge any additional fees under 37 C.F.R. 3.41 that may be required with this communication or credit any overpayment, to Deposit Account No. 01-0467. A duplicate copy of this form is enclosed.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Paul D. Greeley

Name of Person Signing

Signature

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1/14/04

Date

Total number of pages including cover sheet, attachments and document: 6.

PATENT

## **CORPORATE ASSIGNMENT**

WHEREAS, **Arch Specialty Chemicals, Inc.**, a Delaware corporation, with its principal place of business at 501 Merritt 7, P.O. Box 5204, Norwalk, Connecticut 06856 (hereinafter referred to as "Assignor"), is the owner of inventions pertaining to the inventions that are fully described in attached Schedule A (hereinafter referred to as "the Patents and Patent Applications"); and

WHEREAS, **Planar Solutions LLC**, a Delaware corporation, with its principal place of business at 3301 Sutton Road, Adrain, Michigan 49221 (hereinafter referred to as "Assignee"), wishes to acquire the entire right, title and interest in and to the invention, as well as to the Patents and Patent Applications and all other corresponding foreign patent rights;

NOW THEREFORE, for valuable and legally sufficient considerations, receipt of which are hereby acknowledged, the Assignor sells, assigns and transfers to Assignee, its successors and assigns, the entire right, title and interest for the United States in and to the invention and the Patents and Patent Applications for the full term of any Letters Patent which issues therefrom;

The Assignor also sells, assigns and transfers to Assignee the entire right, title and interest in and to the invention and application for Letters Patent and Letters Patent therefor in all countries foreign to the United States, including all rights under the International Convention. The Assignor further authorizes Assignee to apply for Letters Patent in foreign countries in the name of the inventors who have previously assigned this right and this invention to Assignor, and to claim the priority of the filing date of the United States Application under the provisions of the International Convention;

The Assignor further agrees, for itself and its legal representatives, it will assist or direct the inventors to assist Assignee in the prosecution before the United States Patent Office and the Federal Courts of this application, and other applications for Letters Patent including renewals, continuations, continuation-in-parts, divisions, reissues and substitutions, that the Assignee elects to make covering the invention. The Assignor vests in Assignee like exclusive

title in and to all such other applications and Letters Patent. The Assignor will execute or direct the inventors to execute and deliver to Assignee any documents which may be requested by Assignee to carry out the terms of this Assignment; and

The Commissioner of Patents and Trademarks of the United States is authorized and requested to issue Letters Patent of the United States to Assignee. The Assignor also authorizes and requests the equivalent authorities in foreign countries to issue the patents of foreign countries to Assignee.

IN WITNESS WHEREOF, Assignor has caused this Assignment to be executed by its duly authorized officer effective as of the 18 day of DECEMBER, 2003.

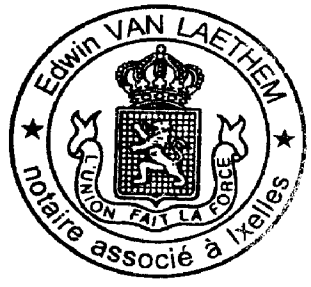
Arch Specialty Chemicals, Inc.

By: *Philippe Gouby*  
Name: Philippe GOUBY  
Title: President

STATE OF \_\_\_\_\_ )  
  ) SS  
COUNTY OF \_\_\_\_\_ )

Sworn to and subscribed before me this \_\_\_\_\_ day of \_\_\_\_\_, 2003.

\_\_\_\_\_  
Notary Public



Edwin VAN LAETHEM, associate notary public at Ixelles (Brussels), hereby certifies that this (these) is (are) the authentic signature(s) of *Philippe Gouby*

~~on~~ 22nd of December 2003

*Edwin Van Laethem*

SCHEDULE A

<u>Country</u>	<u>Appln./Patent No.</u>	<u>Filing/Issue Date</u>	<u>Title</u>
US	09/845,549	April 30, 2001	CHEMICAL MECHANICAL POLISHING SLURRY COMPOSITION FOR POLISHING CONDUCTIVE AND NON-CONDUCTIVE LAYERS ON SEMICONDUCTOR WAFERS
US	10/268,254	October 9, 2002	CHEMICAL MECHANICAL POLISHING SLURRY COMPOSITION FOR POLISHING CONDUCTIVE AND NON-CONDUCTIVE LAYERS ON SEMICONDUCTOR WAFERS
European	01922992.1	April 2, 2001	READY-TO-USE STABLE CHEMICAL-MECHANICAL POLISHING SLURRIES
Japan	2002-509430	April 2, 2001	READY-TO-USE STABLE CHEMICAL-MECHANICAL POLISHING SLURRIES
South Korea	1020037000216	April 2, 2001	READY-TO-USE STABLE CHEMICAL-MECHANICAL POLISHING SLURRIES
Singapore	200207263-5	April 2, 2001	READY-TO-USE STABLE CHEMICAL-MECHANICAL POLISHING SLURRIES
Taiwan	90113232	May 31, 2001	READY-TO-USE STABLE CHEMICAL-MECHANICAL POLISHING SLURRIES

PCT	PCT/US01/10491	April 2, 2001	READY-TO-USE STABLE CHEMICAL-MECHANICAL POLISHING SLURRIES
US	10/281,905	October 28, 2002	A CONTINUOUS CHEMICAL MECHANICAL POLISHING PROCESS FOR POLISHING MULTIPLE CONDUCTIVE AND NON-CONDUCTIVE LAYERS ON SEMICONDUCTOR WAFERS
	<u>Patent No.</u>	<u>Issue Date</u>	<u>Title</u>
US	6,468,913	October 22, 2002	READY-TO-USE STABLE CHEMICAL-MECHANICAL POLISHING SLURRIES